

Description

The TCS1470K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

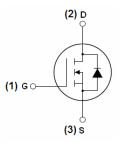
V_{DS} =40V,I_D =70A

$$\begin{split} R_{DS(ON)} <& 5m\Omega \text{ @ } V_{GS} =& 10V \\ R_{DS(ON)} <& 6.5m\Omega \text{ @ } V_{GS} =& 4.5V \end{split}$$

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply



Schematic diagram



TO-252-2L top view

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	70	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	48	Α
Pulsed Drain Current	I _{DM}	260	А
Maximum Power Dissipation	P _D	55	W
Derating factor		0.43	W/°C
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{eJC}	2.3	°C/W
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